



Product Change Notice

Micron PCN: 31138

Date: 1/06/2014

This document supersedes the original PCN #31138, dated 1/06/2013. Changes to the Date: should have read 1/06/2014.

Type Of Change:	Die Shrink, End of Life	
Title of Change:	J4X3 End Of Life, Die Shrink to J4R3	
Description of Change:	Micron's J4X3 (8Gb 2xM60A SLC NAND + 4Gb 2xT79M DDR1 SDRAM) 137b and 168b MCPs are going end of life. 168b will be replaced with J4R3.	
Reason for Change:	Optimization of Manufacturing Efficiency	
Contact Information:	<u>Marketing Contact</u> AMANDA BRONSON Micron Technology, Inc. ASBRONSO@MICRON.COM	<u>Engineering Contact</u> TODD LEGLER Micron Semiconductor Prds TLEGLER@MICRON.COM

Product Affected: J4X3 137b and 168b

Affected Micron Part Number	Replacement Part Number
MT29C8G96MAZBADKD-5 E WT	Contact Sales Representative
MT29C8G96MAZBADKD-5 IT	Contact Sales Representative
MT29C8G96MAZBADKD-5 WT	Contact Sales Representative
MT29C8G96MAZBADJV-5 WT	MT29C8G96MAZBBDJV-48 IT
MT29C8G96MAYBADJV-5 WT	Contact Sales Representative
MT29C8G96MAYBADKD-5 WT	Contact Sales Representative
MT29C8G96MAZBADJV-5 IT	MT29C8G96MAZBBDJV-48 IT

Micron Sites Affected: All Sites

Product Availability:

Replacement Part:

Sample Available: April 2014

Qual Data Available: April 2014

Product Ship Date: May 2014

Current Affected Part:

Last Time Buy: 28-Mar-2014

Last Time Ship: 31-Oct-2014

Orders placed prior to the LTB date are subject to current inventory levels, which may vary based on market conditions and customer demand. Early orders are encouraged.